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Vishay Siliconix

N-Channel 30 V (D-S) MOSFET with Schottky Diode



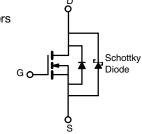
PRODUCT SUMMARY	
V _{DS} (V)	30
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0027
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0040
Q _g typ. (nC)	17.5
I _D (A)	60 ^{a, g}
Configuration	Single

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- SkyFET[®] with monolithic Schottky diode
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Personal computers and servers
- Synchronous buck
- Synchronous rectification
- DC/DC conversion



ORDERING INFORMATION

Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiRC06DP-T1-GE3

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unless	s otherwise note	d)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	30	V
Gate-source voltage		V _{GS}	+20, -16	v
	T _C = 25 °C		60 ^g	
Continuous drain surrant (T 150 °C)	T _C = 70 °C		60 ^g	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	32 ^{b, c}	
	T _A = 70 °C		25.6 ^{b, c}	•
Pulsed drain current (t = 300 µs)	·	I _{DM}	100	— A
	T _C = 25 °C		60 ^g	
Continuous source-drain diode current	T _A = 25 °C	I _S	7.1 ^{b, c}	
Single pulse avalanche current	L = 0.3 mH	I _{AS}	15	
Single pulse avalanche energy	L = 0.3 MH	E _{AS}	11.25	mJ
	T _C = 25 °C		50	
Moving a power dissinction	T _C = 70 °C		32	10/
Maximum power dissipation	T _A = 25 °C	P _D	5 ^{b, c}	— W
	T _A = 70 °C		3.2 ^{b, c}	
Operating junction and storage temperature rar	nge	T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) d, e		260	-0

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^{b,f}	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.9	2.5	0/11

Notes

- a. Based on T_C = 25 $^\circ C$
- b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

- d. See solder profile (www.vishav.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: Manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 70 °C/W

g. Package limit

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S17-1589-Rev. A, 16-Oct-17
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1

Document Number: 62942

For technical questions, contact: pmostechsupport@vishay.com



HALOGEN

FREE

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•	•			•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	
Drain-source breakdown voltage (transient) ^c	V _{DSt}	$V_{GS} = 0 \; V, \; I_{D(aval)} = 15 \; A, \; t_{transcient} \leq 50 \; ns$	36	-	-	V
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	2.1	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = +20, -16 V$	-	-	± 100	nA
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	0.02	0.10	
Zero gate voltage drain current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	0.13	1	mA
On-state drain current ^a	I _{D(on)}	$V_{DS} \geq 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	А
Ducia comuna en etete recistence à	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	0.0022	0.0027	0
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0032	0.0040	Ω
Forward transconductance ^a	g fs	V _{DS} = 10 V, I _D = 15 A	-	120	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	2455	-	
Output capacitance	C _{oss}		-	350	-	
Reverse transfer capacitance	C _{rss}	$V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz$	-	60	-	pF
C _{rss} /C _{iss} ratio			-	0.025	0.050	
	<u> </u>	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	38.5	58	
Total gate charge	Qg		-	17.5	27	
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$	-	6.3	-	nC
Gate-drain charge	Q _{gd}		-	2.8	-	
Output charge	Q _{oss}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	29	-	
Gate resistance	Rg	f = 1 MHz	0.4	1.15	2	Ω
Turn-on delay time	t _{d(on)}		-	12	24	
Rise time	tr	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	-	14	28	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	23	46	
Fall time	t _f		-	8	16	
Turn-on delay time	t _{d(on)}		-	29	58	ns
Rise time	tr	$V_{DD} = 15 \text{ V}, \text{ R}_1 = 1.5 \Omega$	-	50	100	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ Å}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$	-	20	40	
Fall time	t _f		-	9	18	
Drain-Source Body Diode Characteristic	s					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	60	
Pulse diode forward current (t = 100 μ s)	I _{SM}		-	-	100	A
Body diode voltage	V _{SD}	I _S = 5 A	-	0.47	0.7	V
Body diode reverse recovery time	t _{rr}		-	31	62	ns
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	19	38	nC
Reverse recovery fall time	ta	$T_J = 25 \ ^\circ C$	-	16	-	
Reverse recovery rise time	t _b	4	-	15	-	ns

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. T_{CASE} = 25 °C; Expected voltage stress during 100 % UIS test. Production data log is not available

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

S17-1589-Rev. A, 16-Oct-17	
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2

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- 55 °C

4.0

Тc

3.2

2.4

18

V_{GS} = 10 V

50

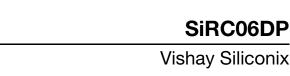
75

V_{GS} = 4.5 V

100

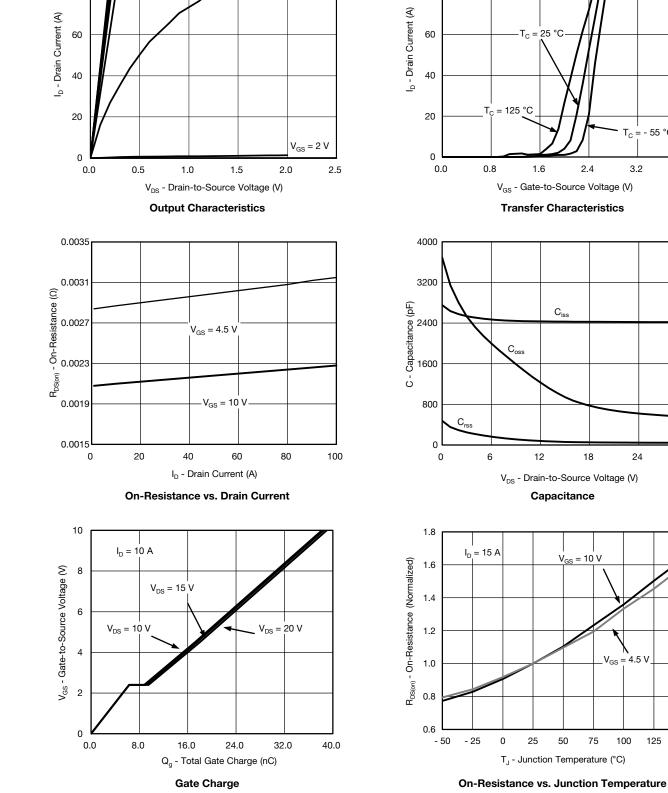
24

30



100

80



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $V_{GS} = 3 V$

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= 10 V thru 4 V

GS

ISHAY

100

80

S17-1589-Rev. A, 16-Oct-17

Document Number: 62942

125

150

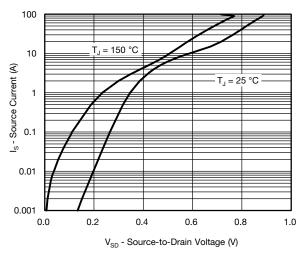
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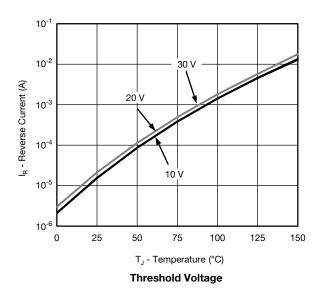


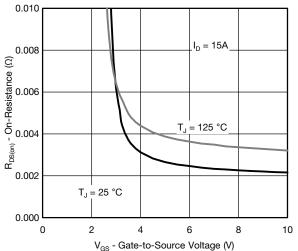
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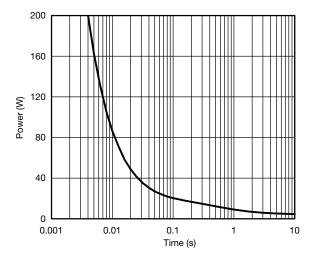


Source-Drain Diode Forward Voltage

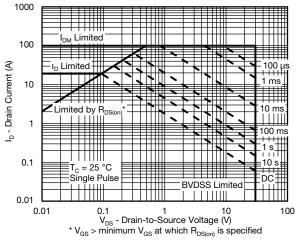




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area

S17-1589-Rev. A, 16-Oct-17

Document Number: 62942

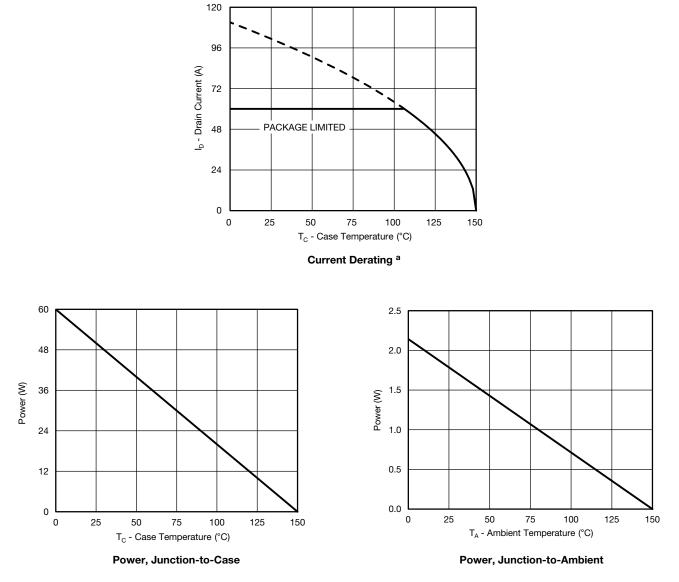
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



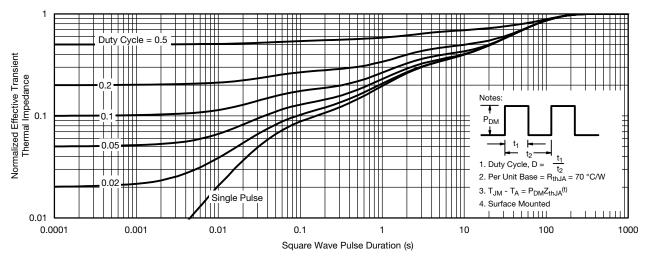
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

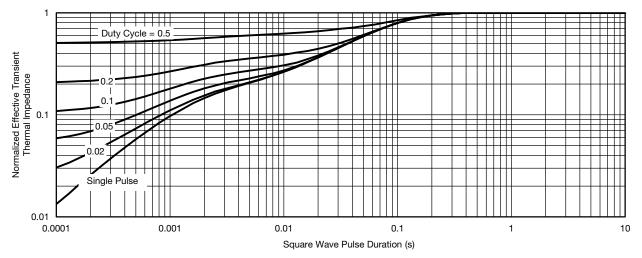


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62942.

6

D2

E3

Backside View of Dual Pad



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PowerPAK[®] SO-8, (Single/Dual)



Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
А	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.00	
b	0.33	0.41	0.51	0.013	0.016	0.02	
С	0.23	0.28	0.33	0.009	0.011	0.01	
D	5.05	5.15	5.26	0.199	0.203	0.20	
D1	4.80	4.90	5.00	0.189	0.193	0.19	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.		0.0225 typ.			
D5		3.98 typ. 0.157 typ.					
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.23	
E2	3.48	3.66	3.84	0.137	0.144	0.15	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4		0.75 typ.			0.030 typ.		
е		1.27 BSC			0.050 BSC		
К		1.27 typ.		0.050 typ.			
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М		0.125 typ.			0.005 typ.		

1



Application Note 826

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RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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